# N-Channel SuperFET ${ }^{\circledR}$ II MOSFET 

## 800 V, 8 A, 850 m $\Omega$

## Features

- Typ. $R_{\text {DS(on) }}=710 \mathrm{~m} \Omega$ (Typ.)
- Ultra Low Gate Charge (Typ. $\mathrm{Q}_{\mathrm{g}}=22 \mathrm{nC}$ )
- Low $\mathrm{E}_{\text {oss }}$ (Typ. 2.3 uJ @ 400V)
- Low Effective Output Capacitance (Typ. Coss(eff.) $=106$ pF)
- $100 \%$ Avalanche Tested
- RoHS Compliant
- ESD Improved Capability


## Applications

- AC - DC Power Supply
- LED Lighting


## Description

SuperFET ${ }^{\circledR}$ II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.


TO-220F


Absolute Maximum Ratings $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise noted.

| Symbol | Parameter |  | FCPF850N80Z | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DSS }}$ | Drain to Source Voltage |  | 800 | V |
| $V_{\text {GSS }}$ | Gate to Source Voltage | - DC | $\pm 20$ | V |
|  |  | - AC (f> 1 Hz ) | $\pm 30$ |  |
| $\mathrm{I}_{\mathrm{D}}$ | Drain Current | - Continuous ( $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ ) | 8.0* | A |
|  |  | - Continuous ( $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ ) | 5.1* |  |
| $\mathrm{I}_{\mathrm{DM}}$ | Drain Current | - Pulsed (Note 1) | 18* | A |
| $\mathrm{E}_{\text {AS }}$ | Single Pulsed Avalanche Energy (Note 2) |  | 114 | mJ |
| $\mathrm{I}_{\text {AR }}$ | Avalanche Current (Note 1) |  | 1.2 | A |
| $\mathrm{E}_{\mathrm{AR}}$ | Repetitive Avalanche Energy (Note 1) |  | 0.284 | mJ |
| dv/dt | MOSFET dv/dt |  | 100 | V/ns |
|  | Peak Diode Recovery dv/dt (Note 3) |  | 20 |  |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation | $\left(\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right)$ | 28.4 | W |
|  |  | - Derate Above $25^{\circ} \mathrm{C}$ | 0.24 | W/ ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{J},} \mathrm{T}_{\text {STG }}$ | Operating and Storage Temperature Range |  | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds |  | 300 | ${ }^{\circ} \mathrm{C}$ |

*Drain current limited by maximum junction temperature, with heatsink.
Thermal Characteristics

| Symbol | Parameter | FCPF850N80Z | Unit |
| :--- | :--- | :---: | :---: |
| $\mathrm{R}_{\theta \mathrm{OC}}$ | Thermal Resistance, Junction to Case, Max. | 4.4 | $\mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\theta \mathrm{JA}}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5 |  |

## Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FCPF850N80Z | FCPF850N80Z | TO-220F | Tube | N/A | N/A | 50 units |

Electrical Characteristics $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Off Characteristics |  |  |  |  |  |  |
| BV ${ }_{\text {DSS }}$ | Drain to Source Breakdown Voltage | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}, \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | 800 | - | - | V |
| $\begin{aligned} & \Delta \mathrm{BV}_{\mathrm{DSS}} \\ & I \Delta \mathrm{~T}_{\mathrm{J}} \\ & \hline \end{aligned}$ | Breakdown Voltage Temperature Coefficient | $\mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}$, Referenced to $25^{\circ} \mathrm{C}$ | - | 0.8 | - | $\mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| IDSs | Zero Gate Voltage Drain Current | $\mathrm{V}_{\mathrm{DS}}=800 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | - | - | 25 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DS}}=640 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ | - | - | 250 |  |
| IGSS | Gate to Body Leakage Current | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ | - | - | $\pm 10$ | $\mu \mathrm{A}$ |

On Characteristics

| $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}, \mathrm{I}_{\mathrm{D}}=0.6 \mathrm{~mA}$ | 2.5 | - | 4.5 | V |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{R}_{\mathrm{DS}(\text { on })}$ | Static Drain to Source On Resistance | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=3 \mathrm{~A}$ | - | 710 | 850 | $\mathrm{~m} \Omega$ |
| $\mathrm{~g}_{\mathrm{FS}}$ | Forward Transconductance | $\mathrm{V}_{\mathrm{DS}}=20 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=3 \mathrm{~A}$ | - | 3.5 | - | S |

Dynamic Characteristics

| $\mathrm{C}_{\text {iss }}$ | Input Capacitance | $\begin{aligned} & V_{D S}=100 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ | - | 990 | 1315 | pF |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {oss }}$ | Output Capacitance |  | - | 28 | 37 | pF |
| $\mathrm{C}_{\text {rss }}$ | Reverse Transfer Capacitance |  | - | 0.74 | - | pF |
| $\mathrm{C}_{\text {oss }}$ | Output Capacitance | $\mathrm{V}_{\mathrm{DS}}=480 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 15 | - | pF |
| $\mathrm{C}_{\text {oss(eff.) }}$ | Effective Output Capacitance | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}$ to $480 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | - | 106 | - | pF |
| $\mathrm{Q}_{\mathrm{g} \text { (tot) }}$ | Total Gate Charge at 10V | $V_{\text {DS }}=640 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=6 \mathrm{~A}$,$\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}$(Note 4) | - | 22 | 29 | nC |
| $\mathrm{Q}_{\mathrm{gs}}$ | Gate to Source Gate Charge |  | - | 5 | - | nC |
| $\mathrm{Q}_{\mathrm{gd}}$ | Gate to Drain "Miller" Charge |  | - | 8.6 | - | nC |
| ESR | Equivalent Series Resistance | $\mathrm{f}=1 \mathrm{MHz}$ | - | 2.4 | - | $\Omega$ |

## Switching Characteristics

| $\mathrm{t}_{\mathrm{d} \text { (on) }}$ | Turn-On Delay Time | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=400 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=6 \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=4.7 \Omega \end{aligned}$ | (Note 4) | - | 16 | 42 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{r}}$ | Turn-On Rise Time |  |  | - | 10 | 30 | ns |
| $\mathrm{t}_{\mathrm{d} \text { (off) }}$ | Turn-Off Delay Time |  |  | - | 40 | 90 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Turn-Off Fall Time |  |  | - | 4.5 | 19 | ns |

## Drain-Source Diode Characteristics

| $\mathrm{I}_{\mathrm{S}}$ | Maximum Continuous Drain to Source Diode Forward Current | - | - | 8 | A |
| :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{SM}}$ | Maximum Pulsed Drain to Source Diode Forward Current | - | - | 18 | A |
| $\mathrm{~V}_{\mathrm{SD}}$ | Drain to Source Diode Forward Voltage | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{SD}}=6 \mathrm{~A}$ | - | - | 1.2 |
| $\mathrm{t}_{\mathrm{rr}}$ | Reverse Recovery Time | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{SD}}=6 \mathrm{~A}$, | V |  |  |
| $\mathrm{Q}_{\mathrm{rr}}$ | Reverse Recovery Charge | $\mathrm{dI}_{\mathrm{F}} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ | - | 318 | - |
| nms |  |  |  |  |  |
|  |  | - | 4.5 | - | $\mu \mathrm{C}$ |

Notes:

1. Repetitive rating: pulse width limited by maximum junction temperature.
2. $\mathrm{I}_{\mathrm{AS}}=1.2 \mathrm{~A}, \mathrm{~V}_{\mathrm{DD}}=50 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=25 \Omega$, Starting $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$
3. $\mathrm{I}_{\mathrm{SD}} \leq 8 \mathrm{~A}, \mathrm{di} / \mathrm{dt} \leq 200 \mathrm{~A} / \mu \mathrm{s}, \mathrm{V}_{\mathrm{DD}} \leq \mathrm{BV}_{\mathrm{DSS}}$, Starting $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$
4. Essentially independent of operating temperature typical characteristics

## Typical Performance Characteristics

Figure 1. On-Region Characteristics


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage


Figure 5. Capacitance Characteristics


Figure 2. Transfer Characteristics


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature


Figure 6. Gate Charge Characteristics


## Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature


Figure 9. Maximum Safe Operating Area


Figure 11. Eoss vs. Drain to Source Voltage


Figure 8. On-Resistance Variation vs. Temperature


Figure 10. Maximum Drain Current vs. Case Temperature


## Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve



Figure 13. Gate Charge Test Circuit \& Waveform


Figure 14. Resistive Switching Test Circuit \& Waveforms


Figure 15. Unclamped Inductive Switching Test Circuit \& Waveforms



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